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### FGA6065ADF 650 V, 60 A Field Stop Trench IGBT

#### Features

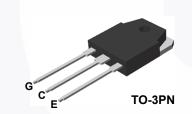
- Maximum Junction Temperature :  $T_J$  = 175 °C
- · Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)}$  = 1.8 V (Typ.) @ I<sub>C</sub> = 60 A
- + 100% of the Parts Tested for  $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- RoHS Compliant

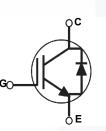
#### **General Description**

This ADF IGBT series adopted Field Stop Trench 3rd generation IGBT which offer extreme low Rds(on) and much faster switching characteristics for outstanding efficiency. And this kind of technology is fully optimized to variety PFC (Power Factor Correction) topology ; Single boost, Multi channel interleaved etc with over 20KHz switching performance. TO3P package provide Super Low thermal resistance for much wider SOA for system stability.

#### Applications

- PFC topology for Home appliance : Single Boost , Multi channel Interleaved etc.
- PFC Topology for Welder





#### **Absolute Maximum Ratings**

Symbol	Description		FGA6065ADF	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage	Collector to Emitter Voltage		V	
\ <i>\</i>	Gate to Emitter Voltage		± 20	V	
V <sub>GES</sub>	Transient Gate to Emitter Voltage		± 30	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	120	А	
'C	Collector Current	@ T <sub>C</sub> = 100°C	60	А	
I <sub>LM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	180	А	
I <sub>CM (2)</sub>	Pulsed Collector Current		180	А	
l <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	60	А	
'F	Diode Forward Current	@ T <sub>C</sub> = 100°C	30	А	
I <sub>FM (2)</sub>	Pulsed Diode Maximum Forward Curren	t	120	А	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	306	W	
· D	Maximum Power Dissipation $@T_{C} = 100^{\circ}C$		153	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1. V\_{CC} = 400 V, V\_{GE} = 15 V, I\_C =180 A, R\_G = 48.4  $\Omega,$  Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

May 2015

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#### Thermal Characteristics

Symbol	Parameter	FGA6065ADF	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.49	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.75	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

#### Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA6065ADF	FGA6065ADF	TO-3PN	Tube	-	-	30

#### Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	ymbol Parameter Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	toriotico					
		1/ - 0/1 - 1 = 1	650	-	_	V
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1 mA	650	-	-	V
ΔBV <sub>CES</sub> / ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE}$ = $V_{GES}$ , $V_{CE}$ = 0 V	-	-	±400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{C}$ = 60 mA, $V_{CE}$ = $V_{GE}$	4.1	5.6	7.6	V
()		I <sub>C</sub> = 60 A, V <sub>GE</sub> = 15 V	-	1.8	2.3	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 60 A, $V_{\rm GE}$ = 15 V, T <sub>C</sub> = 175°C	-	2.3	-	V
Dynamic C	haracteristics					
C <sub>ies</sub>	Input Capacitance		-	2419	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>GE</sub> = 0 V, f = 1MHz	-	82	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	31	-	pF
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	25.6	-	ns
t <sub>r</sub>	Rise Time		-	67.2	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 60 A,	-	71	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	22	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	2.46	- 1	mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	0.52	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	2.98	-	mJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	22.4	-	ns
t <sub>r</sub>	Rise Time		-	63.2	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 60 A,	-	77	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	22	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 175 <sup>o</sup> C	-	3.19	-	mJ
		1		0.71	1	ml
E <sub>off</sub>	Turn-Off Switching Loss		-	0.71	-	mJ

### Electrical Characteristics of the IGBT (Continued)

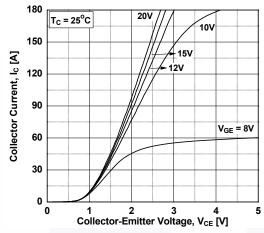
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 60 A, V <sub>GE</sub> = 15 V	-	84	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	15	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	32	-	nC

#### Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions			Min.	Тур.	Мах	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 3	30 A		T <sub>C</sub> = 25°C	-	1.8	2.3	V
					T <sub>C</sub> = 175 <sup>o</sup> C	-	1.7	-	
E <sub>rec</sub>	Reverse Recovery Energy				T <sub>C</sub> = 175 <sup>o</sup> C		233	-	uJ
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs		T <sub>C</sub> = 25°C	-	110	-	ns	
				T <sub>C</sub> = 175 <sup>o</sup> C	-	271			
Q <sub>rr</sub>	Diode Reverse Recovery Charge				T <sub>C</sub> = 25 <sup>o</sup> C	-	400	-	nC
S.II.	block hore recovery charge				T <sub>C</sub> = 175 <sup>o</sup> C	-	1740	-	

## Typical Performance Characteristics

Figure 1. Typical Output Characteristics





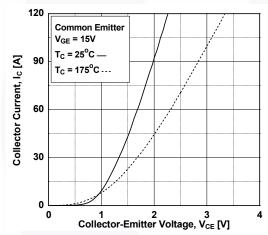


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

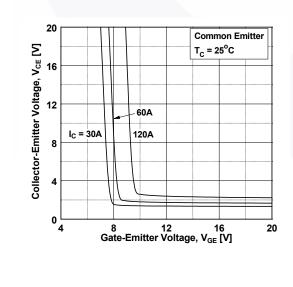
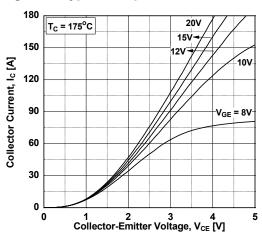


Figure 2. Typical Output Characteristics





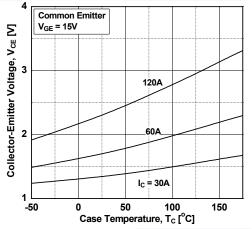
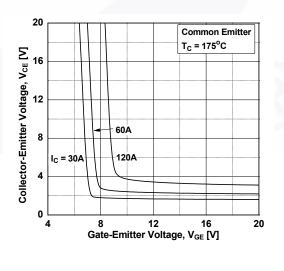
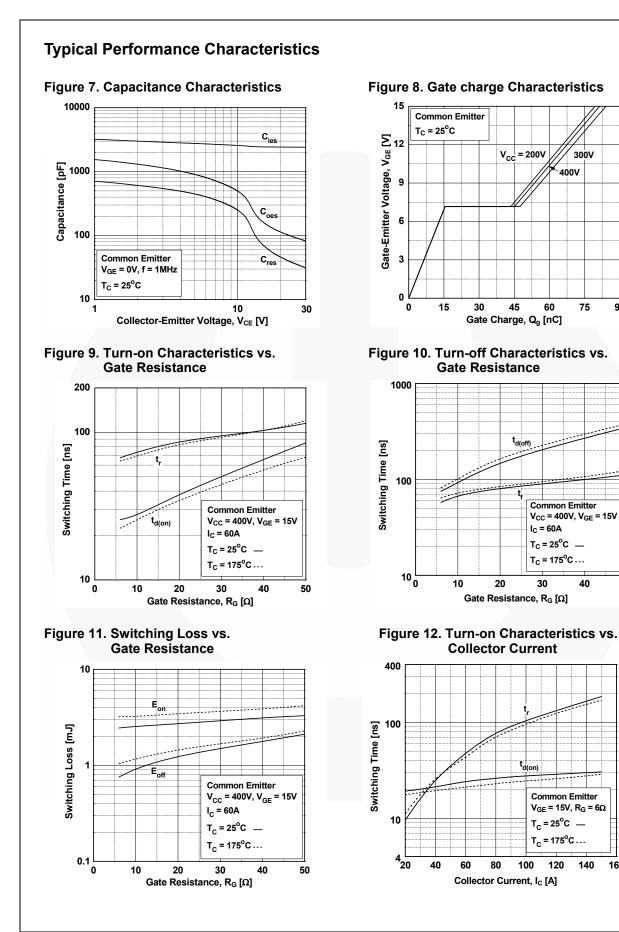


Figure 6. Saturation Voltage vs.  $V_{GE}$ 



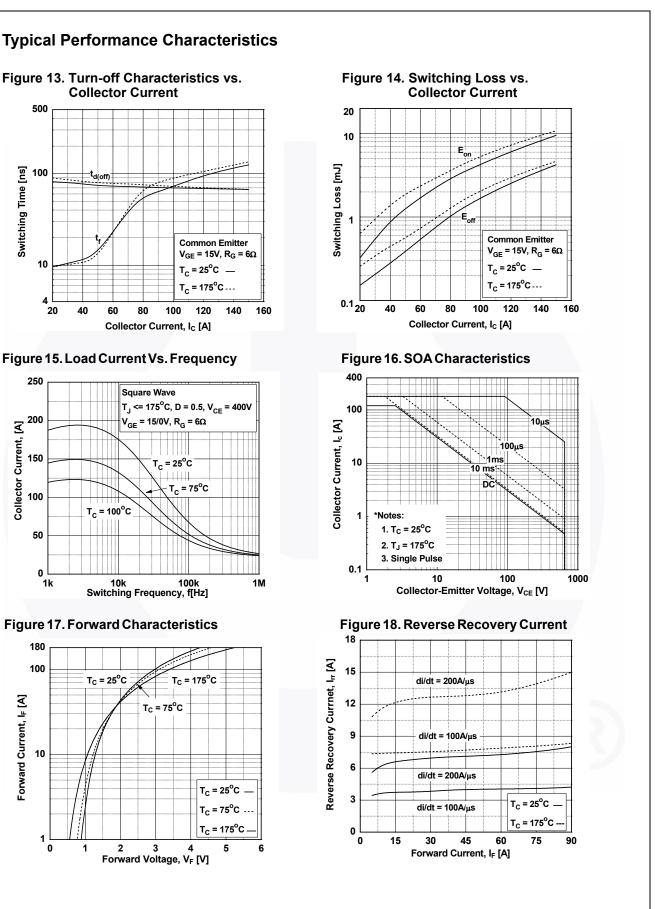
90

50



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160



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1

**Collector Current** 

500

100

10

4

250

200

150

100

50

0

180

100

10

1

0

Forward Current, IF [A]

ĺk

Collector Current, [A]

20

40

60

 $T_c = 100^{\circ}C$ 

T<sub>C</sub> = 25°C

80

Square Wave

10k 100k Switching Frequency, f[Hz]

T<sub>C</sub> = 75<sup>o</sup>C

2 3 4 Forward Voltage, V<sub>F</sub> [V]

V<sub>GE</sub> = 15/0V, R<sub>G</sub> = 6Ω

T<sub>C</sub> = 25°C

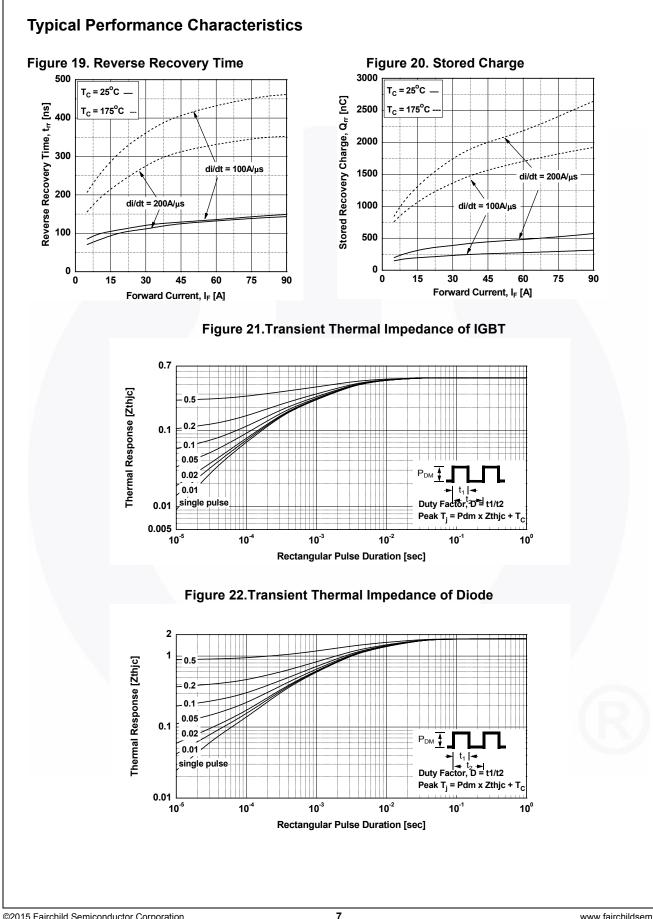
T<sub>C</sub> = 75<sup>o</sup>C

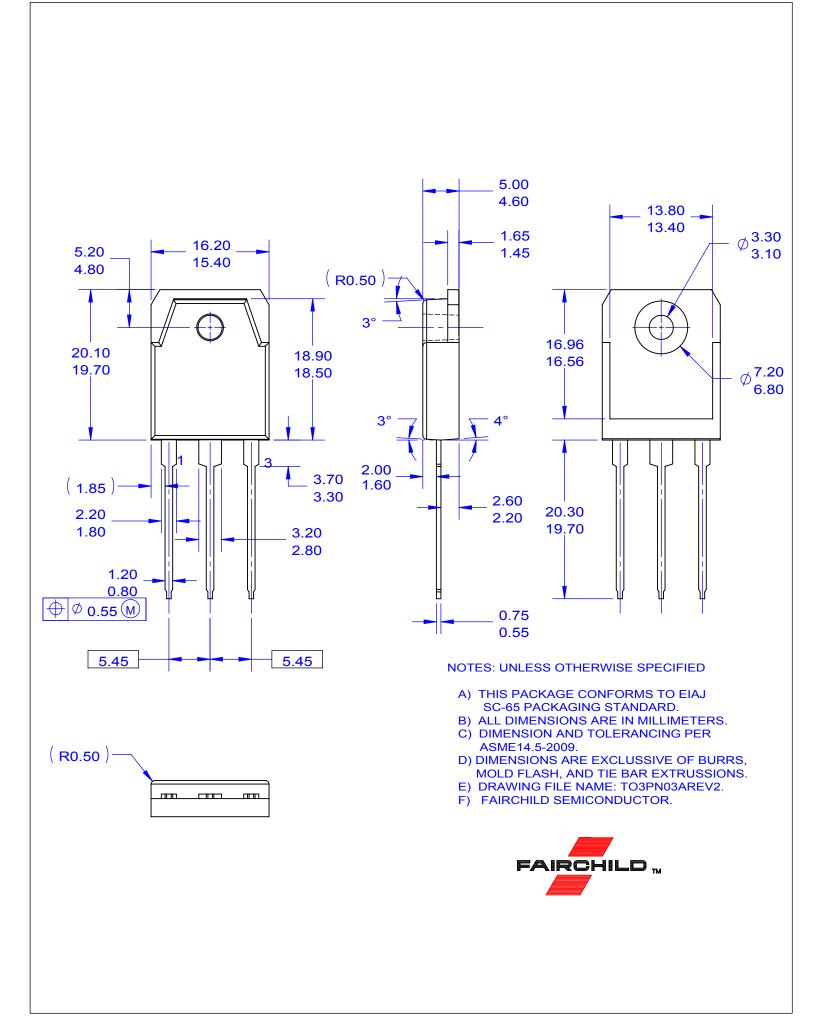
100

Collector Current, Ic [A]

120

Switching Time [ns]





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